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PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

10/019540

APPL NUM	FILING DATE	CLASS	SUBCLASS	GAU	EXAMINER
10019540	01/03/2002	257	2-40	2811	Bradley Sammeister

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2875

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Mulpuri

**CONTINUING DATA VERIFIED:

THIS APPLICATION IS A 371 OF PCT/JP00/04477 07/06/2000

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** FOREIGN APPLICATIONS VERIFIED:

JAPAN 11/192659 07/07/1999

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PG-PUB DO NOT PUBLISH ☐RESCIND ☐

Foreign priority claimed

☒ yes ☐ no

35 USC 119 conditions met

☐ yes ☐ no

Verified and Acknowledged Examiners's initials

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ATTORNEY DOCKET NO

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TITLE : Multilayered body, method for fabricating multilayered body, and semiconductor device

U.S. DEPT. OF COMM./PAT. & TM.-PTO-435L (Rev. 12-94)

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Total Claims	Print Claim for O.G.
ISSUE FEE		DRAWING	
Amount Du	Date Paid	Sheets Drwg.	Print Fig.
<input type="checkbox"/> TERMINAL DISCLAIMER		Assistant Examiner Primary Examiner Application Examiner	
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